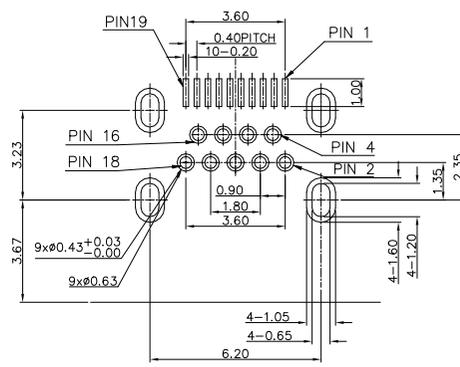
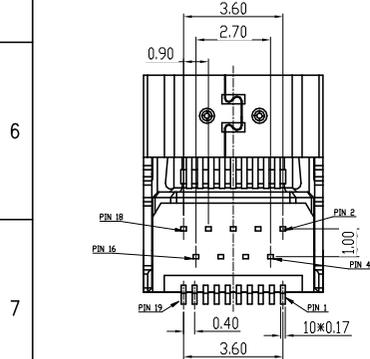
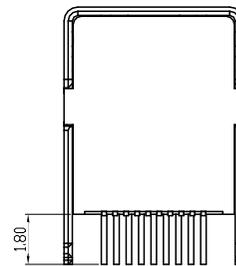
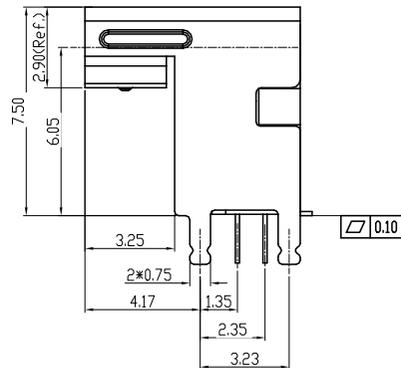
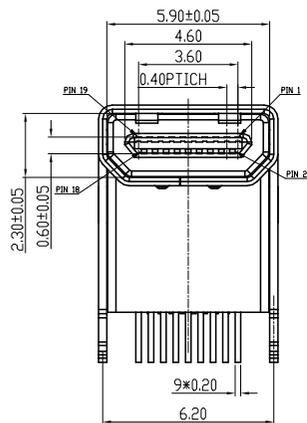
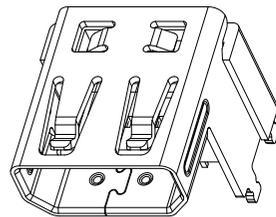
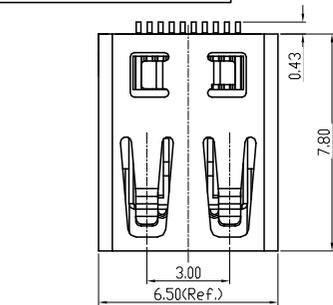


RoHS 2.0+HF

检验规范

- NOTES:
- MATERIAL SPECIFICATION
 - HOUSING: LCP+30% G.F
 - CONTACT: C5191-H T=0.15mm.
 - SHELL: SUS304-1/2H T=0.30mm.
 - MYLAR: KAPTON BASE, POLYIMIDE TAPE.
 - PLATING SPECIFICATION
 - CONTACT: NI40u" UNDER PLATED,GOLD FLASH PLATED ON THE FUNCTIONAL AREA OF CONTACT,GOLD PLATING OR TIN ON SOLDER AREA.
 - SHELL: NICKEL PLATED.
 - MECHANICAL PERFORMANCE
 - INSERTION FORCE: 44.1N (4.5 KGF) MAX.
 - WITHDRAWAL FORCE: 4.9N~25N(0.5KGF~2.5KGF).
 - DURABILITY: 5000 CYCLES.
 - ELECTRICAL PERFORMANCE
 - CURRENT RATING: 0.3A.
 - LLCR: CONTACT: 30 mΩ MAX(INITIAL), SHELL: 50 mΩ MAX(INITIAL).
 - INSULATION RESISTANCE:
 - UNMATED: 100 MΩ MIN. AT 500V DC.
 - MATED: 10 MΩ MIN. AT 150V DC.
 - DIELECTRIC WITHSTAND VOLTAGE:
 - 150V AC/60S(MATED), 250V AC/60S(UNMATED).
 - IR REFLOW:

THE PEAK TEMPERATURE ON BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260±5°C.
 - OPERATING TEMPERATURE RANGE: -20°C~85°C(WITHOUT LOSS FUNCTION).



HD-F C605 R R -E3 XX
1 2 3 4 5 6 7

- HD: HDMI D TYPE
- F: FEMALE
- C605= 中心高6.05mm
- R: DIP+SMT
- R: 90°
- TYPE 码:E3: 加高型规格
- Contact Area plating on contacts
01: G/F 30: Au 30u"

A2		2023.06.09	更新图面发行	董东平	杨章雄	一般公差 GENERAL TOLERANCE X.X ±0.35 X° ±6° X.XX ±0.25 X.X° ±3° X.XXX ±0.15 ▲ MAJOR DIM.	绘图 DR.	料号 PART NO. HD-FC605RR-E301	文件编号 NUMBER ENDPW03	JCTC ®	
A1		2023.05.24	更新PCB Layout发行	董东平	杨章雄						审核 CHK.
A0		2023.05.08	换图框发行	董东平	杨章雄	单位 UNIT mm	核准 APPD.				
版次REV.	日期 DATE	变更内容 DESCRIPTION	审核CHK.	核准APPD.							